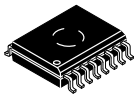
Presettable 4-Bit Down Counters

MC14526B



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SOIC-16 WB
DW SUFFIX
CASE 751G

The MC14526B binary counter is constructed with MOS P-channel and N-channel enhancement mode devices in a monolithic structure.

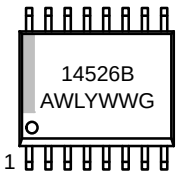
This device is presettable, cascadable, synchronous down counter with a decoded “0” state output for divide-by-N applications. In single stage applications the “0” output is applied to the Preset Enable input. The Cascade Feedback input allows cascade divide-by-N operation with no additional gates required. The Inhibit input allows disabling of the pulse counting function. Inhibit may also be used as a negative edge clock.

This complementary MOS counter can be used in frequency synthesizers, phase-locked loops, and other frequency division applications requiring low power dissipation and/or high noise immunity.

Features

- Supply Voltage Range = 3.0 Vdc to 18 Vdc
- Logic Edge-Clocked Design: Incremented on Positive Transition of Clock or Negative Transition of Inhibit
- Asynchronous Preset Enable
- Capable of Driving Two Low-Power TTL Loads or One Low-Power Schottky TTL Load Over the Rated Temperature Range
- This Device is Pb-Free and is RoHS Compliant

MARKING DIAGRAM



A = Assembly Location
WL, L = Wafer Lot
YY, Y = Year
WW, W = Work Week
G = Pb-Free Package

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 8 of this data sheet.

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
DC Supply Voltage Range	V_{DD}	−0.5 to +18.0	V
Input or Output Voltage Range (DC or Transient)	V_{in}, V_{out}	−0.5 to V_{DD} + 0.5	V
Input or Output Current (DC or Transient) per Pin	I_{in}, I_{out}	±10	mA
Power Dissipation per Package (Note 1)	P_D	500	mW
Operating Temperature Range	T_A	−55 to +125	°C
Storage Temperature Range	T_{stg}	−65 to +150	°C
Lead Temperature (8-Second Soldering)	T_L	260	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. Operating the device outside its recommended conditions, but still within its maximum rated limits may not cause immediate damage. However, doing so can lead to reduced performance, unpredictable behavior, and potentially shorten the device’s lifespan or reliability.

1. Temperature Derating: “D/DW” Package: –7.0 mW/°C From 65 °C To 125 °C

This device contains protection circuitry to guard against damage due to high static voltages or electric fields. However, precautions must be taken to avoid applications of any voltage higher than maximum rated voltages to this high-impedance circuit. For proper operation, V_{in} and V_{out} should be constrained to the range $V_{SS} \le (V_{in}$ or $V_{out}) \le V_{DD}$.

Unused inputs must always be tied to an appropriate logic voltage level (e.g., either V_{SS} or V_{DD}). Unused outputs must be left open.

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FUNCTION TABLE

Inputs					Output	
Clock	Reset	Inhibit	Preset Enable	Cascade Feedback	"0"	Resulting Function
X	H	X	L	L	L	Asynchronous reset*
X	H	X	H	L	H	Asynchronous reset
X	H	X	X	H	H	Asynchronous reset
X	L	X	H	X	L	Asynchronous preset
↑	L	H	L	X	L	Decrement inhibited
L	L		L	X ↓	L	Decrement inhibited
↓	L	L	L	L	L	No change** (inactive edge)
H	L		L	L ↑	L	No change** (inactive edge)
↑	L	L	L	L	L	Decrement**
H	L		L	L ↓	L	Decrement**

X = Don't Care

NOTES:

* Output "0" is low when reset goes high only it PE and CF are low.

** Output "0" is high when reset is low, only if CF is high and count is 0000.

PIN DESCRIPTIONS

Preset Enable (Pin 3) — If Reset is low, a high level on the Preset Enable input asynchronously loads the counter with the programmed values on P0, P1, P2, and P3.

Inhibit (Pin 4) — A high level on the Inhibit input prevents the Clock from decrementing the counter. With Clock (pin 6) held high, Inhibit may be used as a negative edge clock input.

Clock (Pin 6) — The counter decrements by one for each rising edge of Clock. See the Function Table for level requirements on the other inputs.

Reset (Pin 10) — A high level on Reset asynchronously forces Q0, Q1, Q2, and Q3 low and, if Cascade Feedback is high, causes the "0" output to go high.

"0" (Pin 12) — The "0" (Zero) output issues a pulse one clock period wide when the counter reaches terminal count (Q0 = Q1 = Q2 = Q3 = low) if Cascade Feedback is high and Preset Enable is low. When presetting the counter to a value other than all zeroes, the "0" output is valid after the rising edge of Preset Enable (when Cascade Feedback is high). See the Function Table.

Cascade Feedback (Pin 13) — If the Cascade Feedback input is high, a high level is generated at the "0" output when the count is all zeroes. If Cascade Feedback is low, the "0" output depends on the Preset Enable input level. See the Function Table.

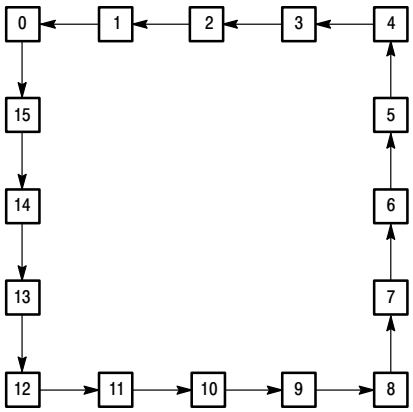
P0, P1, P2, P3 (Pins 5, 11, 14, 2) — These are the preset data inputs. P0 is the LSB.

Q0, Q1, Q2, Q3 (Pins 7, 9, 15, 1) — These are the synchronous counter outputs. Q0 is the LSB.

V_{SS} (Pin 8) — The most negative power supply potential. This pin is usually ground.

V_{DD} (Pin 16) — The most positive power supply potential. V_{DD} may range from 3.0 to 18 V with respect to V_{SS}.

STATE DIAGRAM
MC14526B



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ELECTRICAL CHARACTERISTICS (Voltages Referenced to V_{SS})

Characteristic	Symbol	V_{DD} Vdc	−55 °C Min	−55 °C Max	25 °C Min	25 °C Typ (Note 2)	25 °C Max	125 °C Min	125 °C Max	Unit
Output Voltage “0” Level V_{in} = V_{DD} or 0	V_{OL}	5.0 10 15	− − −	0.05 0.05 0.05	− − −	0 0 0	0.05 0.05 0.05	− − −	0.05 0.05 0.05	Vdc
“1” Level V_{in} = 0 or V_{DD}										
Output Voltage “0” Level V_{in} = V_{DD} or 0	V_{OH}	5.0 10 15	4.95 9.95 14.95	− − −	4.95 9.95 14.95	5.0 10 15	− − −	4.95 9.95 14.95	− − −	Vdc
“1” Level V_{in} = 0 or V_{DD}										
Input Voltage “0” Level (V_O = 4.5 or 0.5 Vdc) (V_O = 9.0 or 1.0 Vdc) (V_O = 13.5 or 1.5 Vdc)	V_{IL}	5.0 10 15	− − −	1.5 3.0 4.0	− − −	2.25 4.50 6.75	1.5 3.0 4.0	− − −	1.5 3.0 4.0	Vdc
“1” Level (V_O = 0.5 or 4.5 Vdc) (V_O = 1.0 or 9.0 Vdc) (V_O = 1.5 or 13.5 Vdc)										
Input Voltage “0” Level (V_O = 4.5 or 0.5 Vdc) (V_O = 9.0 or 1.0 Vdc) (V_O = 13.5 or 1.5 Vdc)	V_{IH}	5.0 10 15	3.5 7.0 11	− − −	3.5 7.0 11	2.75 5.50 8.25	− − −	3.5 7.0 11	− − −	Vdc
“1” Level (V_O = 0.5 or 4.5 Vdc) (V_O = 1.0 or 9.0 Vdc) (V_O = 1.5 or 13.5 Vdc)										
Output Drive Current (V_{OH} = 2.5 Vdc) Source (V_{OH} = 4.6 Vdc) (V_{OH} = 9.5 Vdc) (V_{OH} = 13.5 Vdc)	I_{OH}	5.0 5.0 10 15	−3.0 −0.64 −1.6 −4.2	− − − −	−2.4 −0.51 −1.3 −3.4	−4.2 −0.88 −2.25 −8.8	− − − −	−1.7 −0.36 −0.9 −2.4	− − − −	mAdc
(V_{OL} = 0.4 Vdc) Sink (V_{OL} = 0.5 Vdc) (V_{OL} = 1.5 Vdc)	I_{OL}	5.0 10 15	0.64 1.6 4.2	− − −	0.51 1.3 3.4	0.88 2.25 8.8	− − −	0.36 0.9 2.4	− − −	mAdc
Input Current	I_{in}	15	−	±0.1	−	±0.00001	±0.1	−	±1.0	μAdc
Input Capacitance (V_{in} = 0)	C_{in}	−	−	−	−	5.0	7.5	−	−	pF
Quiescent Current (Per Package)		5.0 10 15	− − −	5.0 10 20	− − −	0.005 0.010 0.015	5.0 10 20	− − −	150 300 600	μAdc
Total Supply Current (Notes 3, 4) (Dynamic plus Quiescent, Per Package) (C_L = 50 pF on all outputs, all buffers switching)		5.0 10 15	I_T = (1.7 μA/kHz) f + I_{DD} I_T = (3.4 μA/kHz) f + I_{DD} I_T = (5.1 μA/kHz) f + I_{DD}							μAdc

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

2. Data labelled “Typ” is not to be used for design purposes but is intended as an indication of the IC’s potential performance.
3. The formulas given are for the typical characteristics only at 25 °C.
4. To calculate total supply current at loads other than 50 pF:

$$I_T(C_L) = I_T(50\ pF) + (C_L - 50)\ Vfk$$

where: I_T is in μA (per package), C_L in pF, V = (V_{DD} – V_{SS}) in volts, f in kHz is input frequency, and k = 0.001.

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SWITCHING CHARACTERISTICS (C_L = 50 pF, T_A = 25 °C) (Note 5)

Characteristic	Symbol	V_{DD}	Min	Typ (Note 6)	Max	Unit
Output Rise and Fall Time t_{TLH}, t_{THL} = (1.5 ns/pF) C_L + 25 ns t_{TLH}, t_{THL} = (0.75 ns/pF) C_L + 12.5 ns t_{TLH}, t_{THL} = (0.55 ns/pF) C_L + 9.5 ns	t_{TLH}, t_{THL} (Figures 4, 5)	5.0 10 15	– – –	100 50 40	200 100 80	ns
Propagation Delay Time (Inhibit Used as Negative Edge Clock) Clock or Inhibit to Q t_{PLH}, t_{PHL} = (1.7 ns/pF) C_L + 465 ns t_{PLH}, t_{PHL} = (0.66 ns/pF) C_L + 197 ns t_{PLH}, t_{PHL} = (0.5 ns/pF) C_L + 135 ns	t_{PLH}, t_{PHL} (Figures 4, 5, 6)	5.0 10 15	– – –	550 225 160	1100 450 320	ns
Clock or Inhibit to “0” t_{PLH}, t_{PHL} = (1.7 ns/pF) C_L + 155 ns t_{PLH}, t_{PHL} = (0.66 ns/pF) C_L + 87 ns t_{PLH}, t_{PHL} = (0.5 ns/pF) C_L + 65 ns		5.0 10 15	– – –	240 130 100	480 260 200	
Propagation Delay Time Pn to Q	t_{PLH}, t_{PHL} (Figures 4, 7)	5.0 10 15	– – –	260 120 100	520 240 200	ns
Propagation Delay Time Reset to Q	t_{PHL} (Figure 8)	5.0 10 15	– – –	250 110 80	500 220 160	ns
Propagation Delay Time Preset Enable to “0”	t_{PHL}, t_{PLH} (Figures 4, 9)	5.0 10 15	– – –	220 100 80	440 200 160	ns
Clock or Inhibit Pulse Width	t_w (Figures 5, 6)	5.0 10 15	250 100 80	125 50 40	– – –	ns
Clock Pulse Frequency (with PE = low)	f_{max} (Figures 4, 5, 6)	5.0 10 15	– – –	2.0 5.0 6.6	1.5 3.0 4.0	MHz
Clock or Inhibit Rise and Fall Time	t_r, t_f (Figures 5, 6)	5.0 10 15	– – –	– – –	15 5 4	μs
Setup Time Pn to Preset Enable	t_{su} (Figure 1)	5.0 10 15	90 50 40	40 15 10	– – –	ns
Hold Time Preset Enable to Pn	t_h (Figure 2)	5.0 10 15	30 30 30	–15 –5 0	– – –	ns
Preset Enable Pulse Width	t_w (Figure 3)	5.0 10 15	250 100 80	125 50 40	– – –	ns
Reset Pulse Width	t_w (Figure 8)	5.0 10 15	350 250 200	175 125 100	– – –	ns
Reset Removal Time	t_{rem} (Figure 8)	5.0 10 15	10 20 30	–110 –30 –20	– – –	ns

5. The formulas given are for the typical characteristics only at 25 °C.
6. Data labelled “Typ” is not to be used for design purposes but is intended as an indication of the IC’s potential performance.

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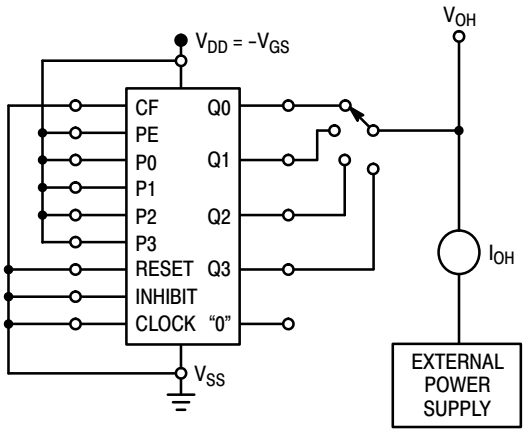


Figure 1. Typical Output Source Characteristics Test Circuit

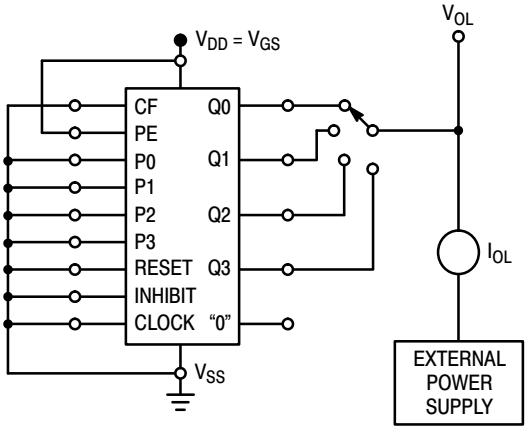


Figure 2. Typical Output Sink Characteristics Test Circuit

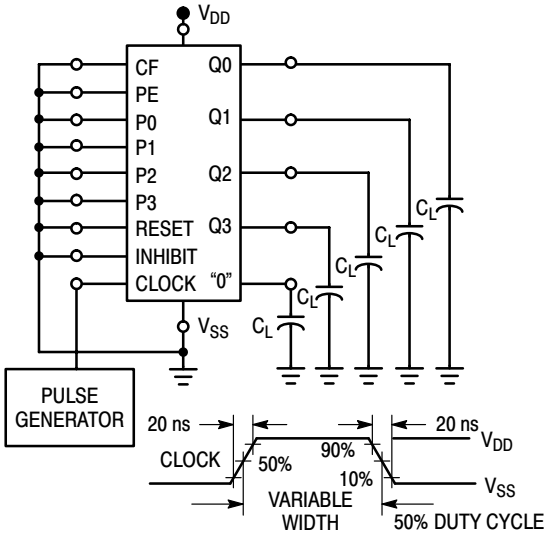
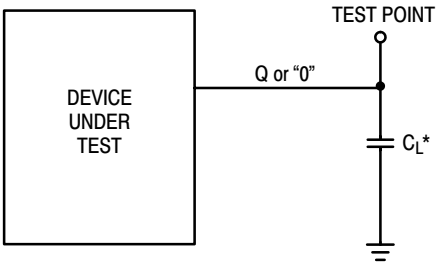


Figure 3. Power Dissipation



* Includes all probe and jig capacitance.

Figure 4. Test Circuit

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SWITCHING WAVEFORMS

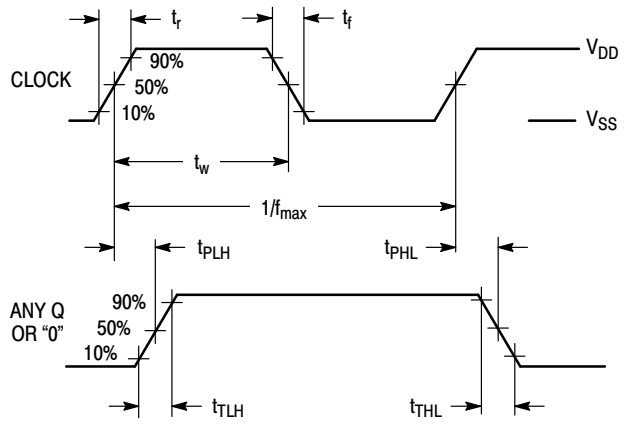

Figure 5.

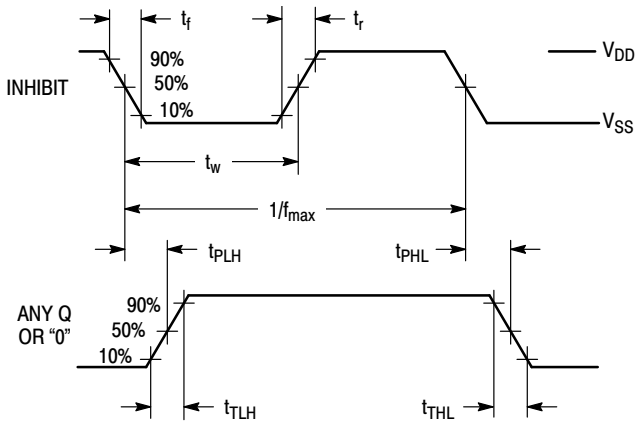

Figure 6.

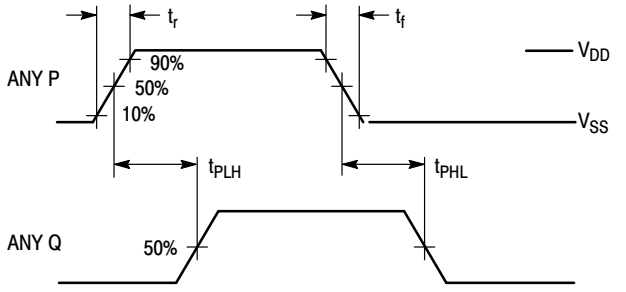

Figure 7.

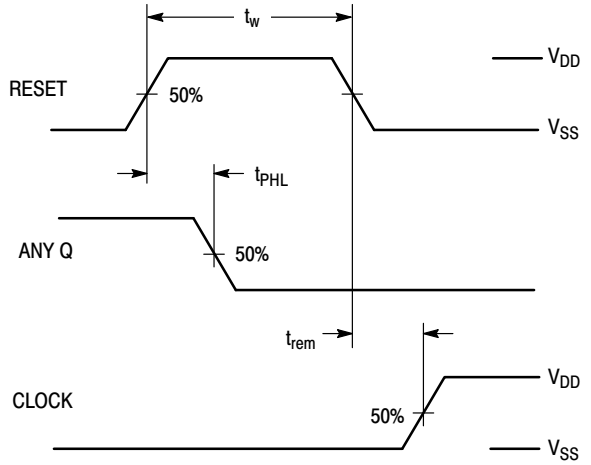

Figure 8.

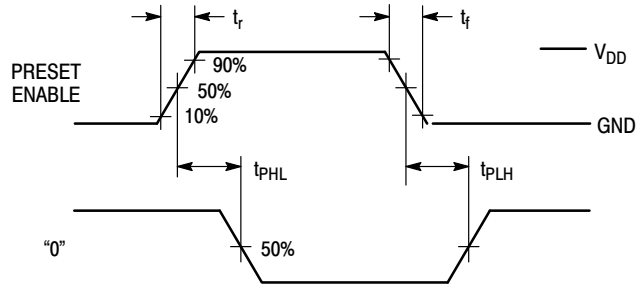

Figure 9.

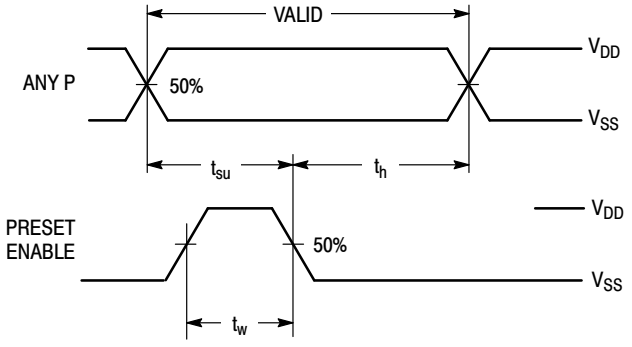

Figure 10.

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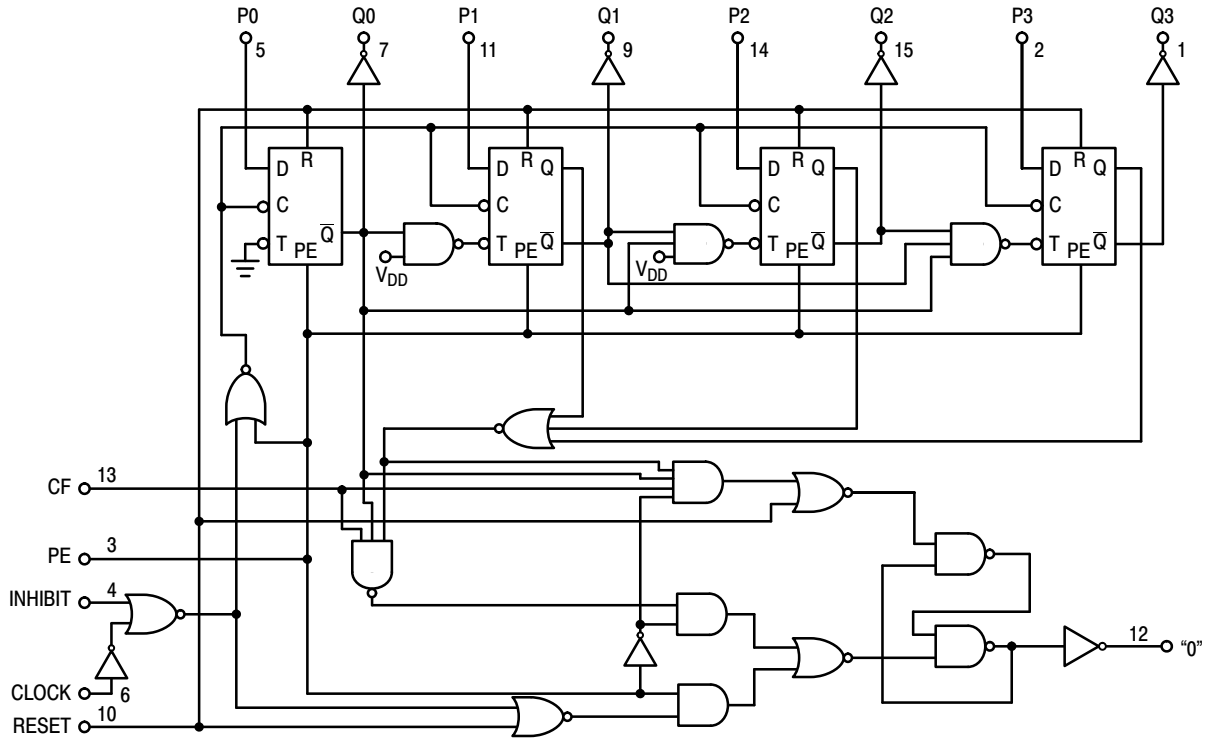
MC14526B LOGIC DIAGRAM
(Binary Down Counter)



APPLICATIONS INFORMATION

Divide-By-N, Single Stage

Figure 11 shows a single stage divide-by-N application.

To initialize counting a number, N is set on the parallel inputs (P0, P1, P2, and P3) and reset is taken high asynchronously. A zero is forced into the master and slave of each bit and, at the same time, the “0” output goes high. Because Preset Enable is tied to the “0” output, preset is enabled. Reset must be released while the Clock is high so the slaves of each bit may receive N before the Clock goes low. When the Clock goes low and Reset is low, the “0” output goes low (if P0 through P3 are unequal to zero).

The counter downcounts with each rising edge of the Clock. When the counter reaches the zero state, an output pulse occurs on “0” which presets N. The propagation delays from the Clock’s rising and falling edges to the “0” output’s rising and falling edges are about equal, making the “0” output pulse approximately equal to that of the Clock pulse.

The Inhibit pin may be used to stop pulse counting. When this pin is taken high, decrementing is inhibited.

Cascaded, Presettable Divide-By-N

Figure 12 shows a three stage cascade application. Taking Reset high loads N. Only the first stage’s Reset pin (least significant counter) must be taken high to cause the preset for all stages, but all pins could be tied together, as shown.

When the first stage’s Reset pin goes high, the “0” output is latched in a high state. Reset must be released while Clock is high and time allowed for Preset Enable to load N into all stages before Clock goes low.

When Preset Enable is high and Clock is low, time must be allowed for the zero digits to propagate a Cascade Feedback to the first non-zero stage. Worst case is from the most significant bit (M.S.B.) to the L.S.B., when the L.S.B. is equal to one (i.e. N = 1).

After N is loaded, each stage counts down to zero with each rising edge of Clock. When any stage reaches zero and the leading stages (more significant bits) are zero, the “0” output goes high and feeds back to the preceding stage. When all stages are zero, the Preset Enable automatically loads N while the Clock is high and the cycle is renewed.

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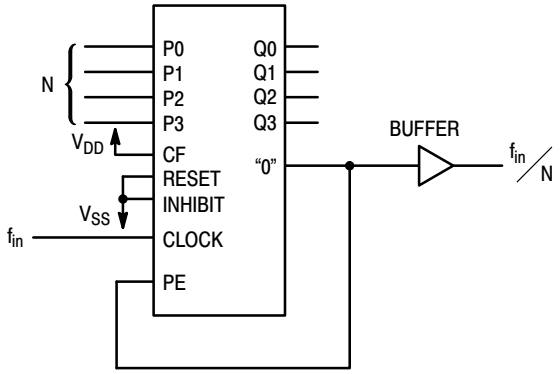

Figure 11. ÷ N Counter

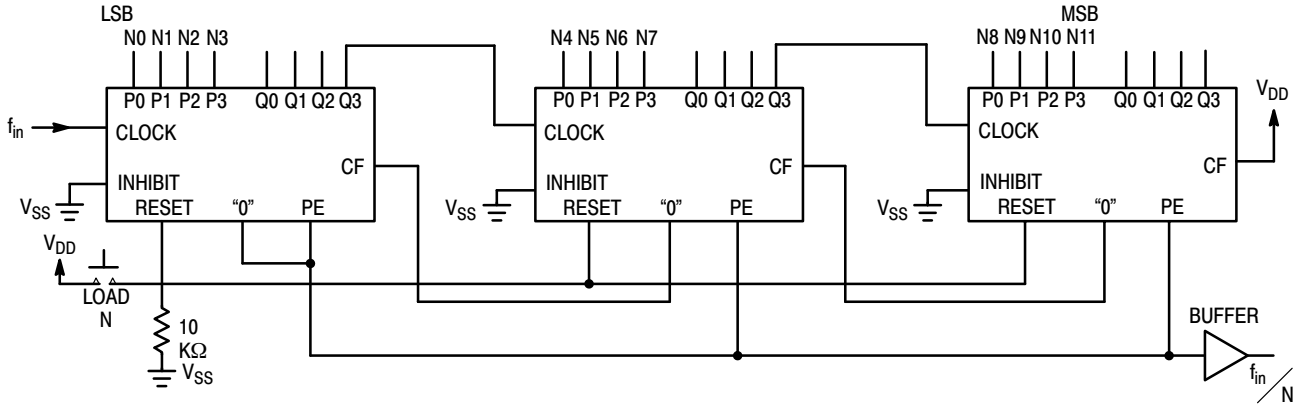

Figure 12. 3 Stages Cascaded

ORDERING INFORMATION

Device	Package	Shipping†
MC14526BDWG	SOIC-16 WB (Pb-Free)	47 Units / Rail
MC14526BDWR2G	SOIC-16 WB (Pb-Free)	1000 / Tape & Reel

† For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

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REVISION HISTORY

Revision	Description of Changes	Date
9	Rebranded the Data Sheet to **onsemi** format.	10/3/2025

This document has undergone updates prior to the inclusion of this revision history table. The changes tracked here only reflect updates made on the noted approval dates.

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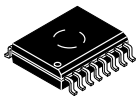

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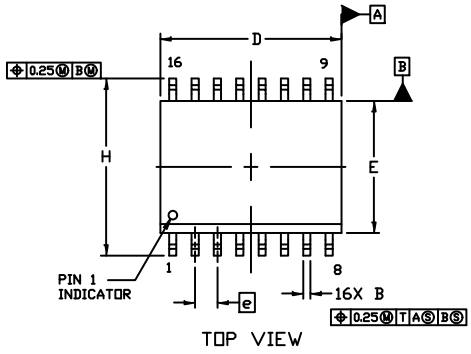
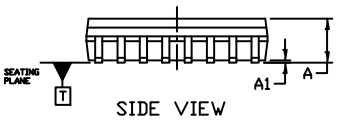
SCALE 1:1

SOIC−16 WB
CASE 751G
ISSUE E

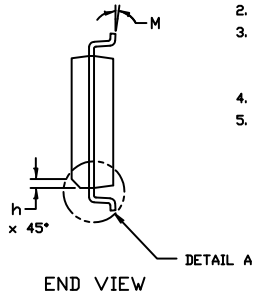
DATE 08 OCT 2021



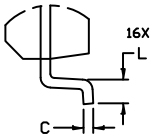
TOP VIEW



SIDE VIEW



END VIEW

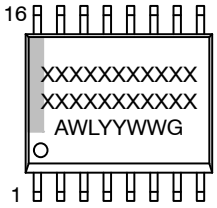


DETAIL A
2X SCALE

NOTES:
1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS
3. DIMENSION b DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE PROTRUSION SHALL BE 0.13 TOTAL IN EXCESS OF B DIMENSION AT MAXIMUM MATERIAL CONDITION.
4. DIMENSIONS D AND E DO NOT INCLUDE MOLD PROTRUSIONS.
5. MAXIMUM MOLD PROTRUSION OR FLASH TO BE 0.15 PER SIDE.

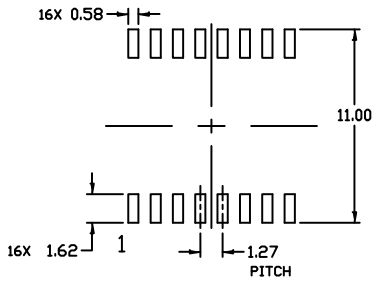
	MILLIMETERS	
DIM	MIN.	MAX.
A	2.35	2.65
A1	0.10	0.25
B	0.35	0.49
C	0.23	0.32
D	10.15	10.45
E	7.40	7.60
e	1.27 BSC	
H	10.05	10.55
h	0.53 REF	
L	0.50	0.90
M	0°	7°

GENERIC MARKING DIAGRAM*



XXXXX = Specific Device Code
A = Assembly Location
WL = Wafer Lot
YY = Year
WW = Work Week
G = Pb−Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb−Free indicator, “G” or microdot “▪”, may or may not be present. Some products may not follow the Generic Marking.



RECOMMENDED
MOUNTING FOOTPRINT

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DESCRIPTION:	**SOIC−16 WB**		**PAGE 1 OF 1**

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